MMSZ4678T1 Series

Preferred Device

Zener Voltage Regulators

500 mW SOD−123 Surface Mount

Three complete series of Zener diodes are offered in the convenient, surface mount plastic SOD−123 package. These devices provide a convenient alternative to the leadless 34−package style.

Features

- 500 mW Rating on FR−4 or FR−5 Board
- Wide Zener Reverse Voltage Range − 1.8 V to 43 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Pb−Free Packages are Available

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic case
FINISH: Corrosion resistant finish, easily solderable
MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:
260°C for 10 Seconds
POLARITY: Cathode indicated by polarity band
FLAMMABILITY RATING: UL 94 V−0

MAXIMUM RATINGS

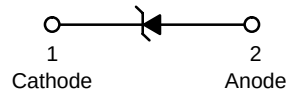
Rating	Symbol	Max	Unit
Total Power Dissipation on FR−5 Board, (Note 1) @ T_L = 75°C Derated above 75°C	P_D	500 6.7	mW mW/°C
Thermal Resistance, (Note 2) Junction−to−Ambient	$R_{\theta JA}$	340	°C/W
Thermal Resistance, (Note 2) Junction−to−Lead	$R_{\theta JL}$	150	°C/W
Junction and Storage Temperature Range	T_J, T_{stg}	−55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR−5 = 3.5 X 1.5 inches, using the minimum recommended footprint.
2. Thermal Resistance measurement obtained via infrared Scan Method.

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SOD−123
CASE 425
STYLE 1

MARKING DIAGRAM



xx = Device Code (Refer to page 3)
M = Date Code
▪ = Pb−Free Package
(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping†
MMSZ4xxxT1	SOD−123	3000/Tape & Reel
MMSZ4xxxT1G	SOD−123 (Pb−Free)	3000/Tape & Reel
MMSZ4xxxT3	SOD−123	10000/Tape & Reel
MMSZ4xxxT3G	SOD−123 (Pb−Free)	10000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DEVICE MARKING INFORMATION

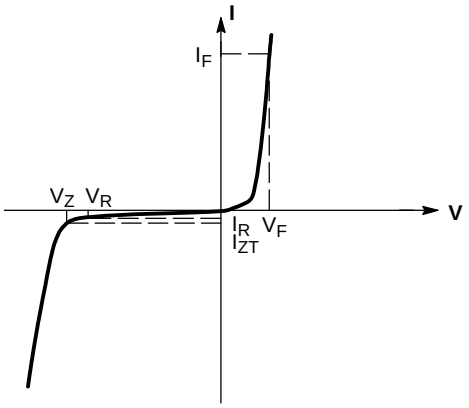
See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

Devices listed in ***bold, italic*** are ON Semiconductor **Preferred** devices. **Preferred** devices are recommended choices for future use and best overall value.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 0.95 V Max. @ I_F = 10 mA)

Symbol	Parameter
V_Z	Reverse Zener Voltage @ I_{ZT}
I_{ZT}	Reverse Current
I_R	Reverse Leakage Current @ V_R
V_R	Reverse Voltage
I_F	Forward Current
V_F	Forward Voltage @ I_F



Zener Voltage Regulator

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 0.9 V Max. @ I_F = 10 mA)

Device*	Device Marking	Zener Voltage (Note 3) V_Z (Volts) Min	Nom	Max	@ I_{ZT} μA	Leakage Current I_R @ V_R μA	Volts
MMSZ4678T1, G	CC	1.71	1.8	1.89	50	7.5	1
MMSZ4679T1, G	CD	1.90	2.0	2.10	50	5	1
MMSZ4680T1, G	***CE***	***2.09***	***2.2***	***2.31***	***50***	***4***	***1***
MMSZ4681T1, G	CF	2.28	2.4	2.52	50	2	1
MMSZ4682T1, G	CH	2.565	2.7	2.835	50	1	1
MMSZ4683T1, G	CJ	2.85	3.0	3.15	50	0.8	1
MMSZ4684T1, G	CK	3.13	3.3	3.47	50	7.5	1.5
MMSZ4685T1, G	***CM***	***3.42***	***3.6***	***3.78***	***50***	***7.5***	***2***
MMSZ4686T1, G	CN	3.70	3.9	4.10	50	5	2
MMSZ4687T1, G	CP	4.09	4.3	4.52	50	4	2
MMSZ4688T1, G	CT	4.47	4.7	4.94	50	10	3
MMSZ4689T1, G	CU	4.85	5.1	5.36	50	10	3
MMSZ4690T1, G	***CV***	***5.32***	***5.6***	***5.88***	***50***	***10***	***4***
MMSZ4691T1, G	CA	5.89	6.2	6.51	50	10	5
MMSZ4692T1, G	CX	6.46	6.8	7.14	50	10	5.1
MMSZ4693T1, G	CY	7.13	7.5	7.88	50	10	5.7
MMSZ4694T1, G	CZ	7.79	8.2	8.61	50	1	6.2
MMSZ4695T1, G	DC	8.27	8.7	9.14	50	1	6.6
MMSZ4696T1, G	DD	8.65	9.1	9.56	50	1	6.9
MMSZ4697T1, G	DE	9.50	10	10.50	50	1	7.6
MMSZ4698T1, G	DF	10.45	11	11.55	50	0.05	8.4
MMSZ4699T1, G	DH	11.40	12	12.60	50	0.05	9.1
MMSZ4700T1, G	DJ	12.35	13	13.65	50	0.05	9.8
MMSZ4701T1, G	DK	13.30	14	14.70	50	0.05	10.6
MMSZ4702T1, G	DM	14.25	15	15.75	50	0.05	11.4
MMSZ4703T1, G †	DN	15.20	16	16.80	50	0.05	12.1
MMSZ4704T1, G	DP	16.15	17	17.85	50	0.05	12.9
MMSZ4705T1, G	DT	17.10	18	18.90	50	0.05	13.6
MMSZ4706T1, G	DU	18.05	19	19.95	50	0.05	14.4
MMSZ4707T1, G	DV	19.00	20	21.00	50	0.01	15.2
MMSZ4708T1, G	DA	20.90	22	23.10	50	0.01	16.7
MMSZ4709T1, G	DX	22.80	24	25.20	50	0.01	18.2
MMSZ4710T1, G	DY	23.75	25	26.25	50	0.01	19.0
MMSZ4711T1, G †	EA	25.65	27	28.35	50	0.01	20.4
MMSZ4712T1	EC	26.60	28	29.40	50	0.01	21.2
MMSZ4713T1, G	ED	28.50	30	31.50	50	0.01	22.8
MMSZ4714T1, G	EE	31.35	33	34.65	50	0.01	25.0
MMSZ4715T1, G	EF	34.20	36	37.80	50	0.01	27.3
MMSZ4716T1, G	EH	37.05	39	40.95	50	0.01	29.6
MMSZ4717T1, G	EJ	40.85	43	45.15	50	0.01	32.6

3. Nominal Zener voltage is measured with the device junction in thermal equilibrium at T_L = 30°C ±1°C.
*The “G’’ suffix indicates Pb−Free package available.
†MMSZ4703 and MMSZ4711 Not Available in 10,000/Tape & Reel

TYPICAL CHARACTERISTICS

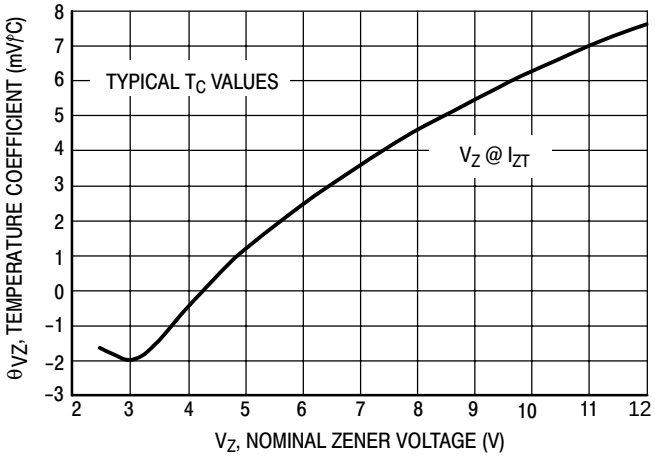


Figure 1. Temperature Coefficients (Temperature Range −55°C to +150°C)

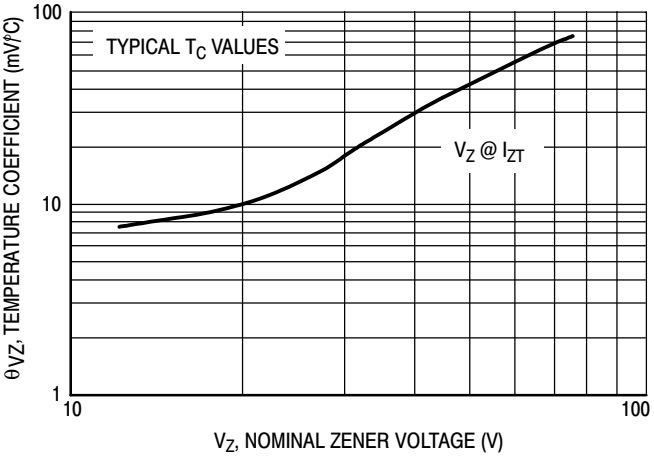


Figure 2. Temperature Coefficients (Temperature Range −55°C to +150°C)

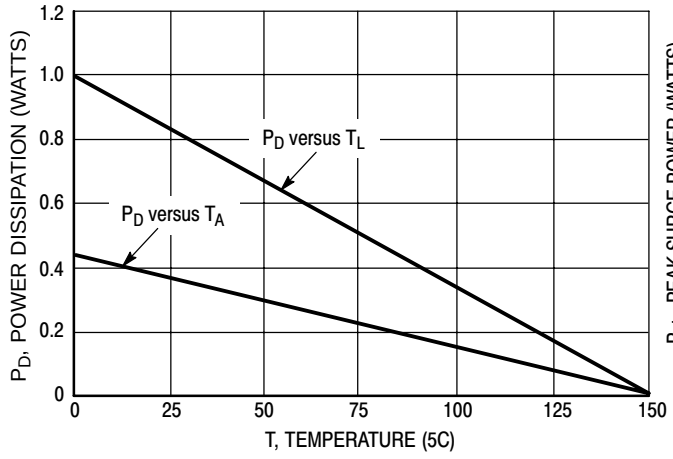


Figure 3. Steady State Power Derating

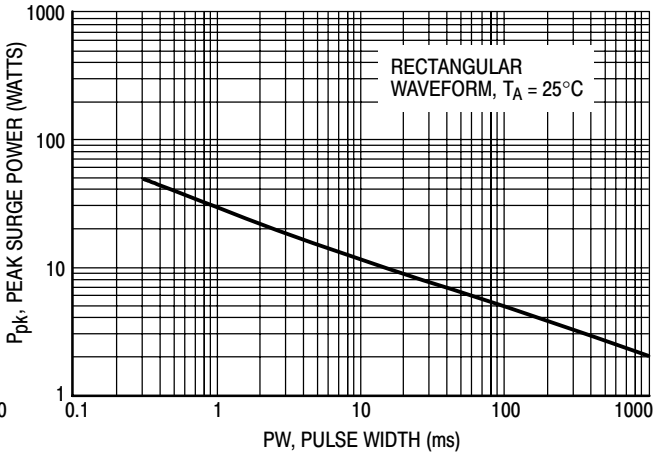


Figure 4. Maximum Nonrepetitive Surge Power

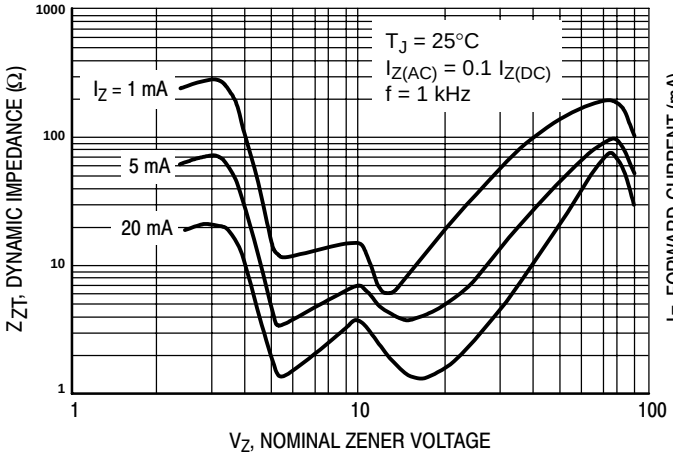


Figure 5. Effect of Zener Voltage on Zener Impedance

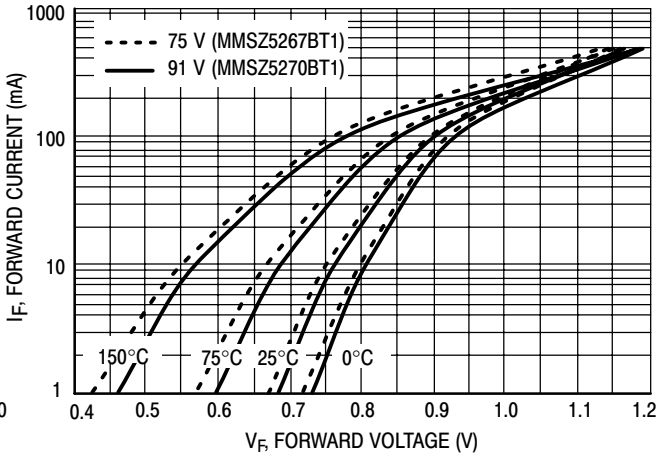


Figure 6. Typical Forward Voltage

TYPICAL CHARACTERISTICS

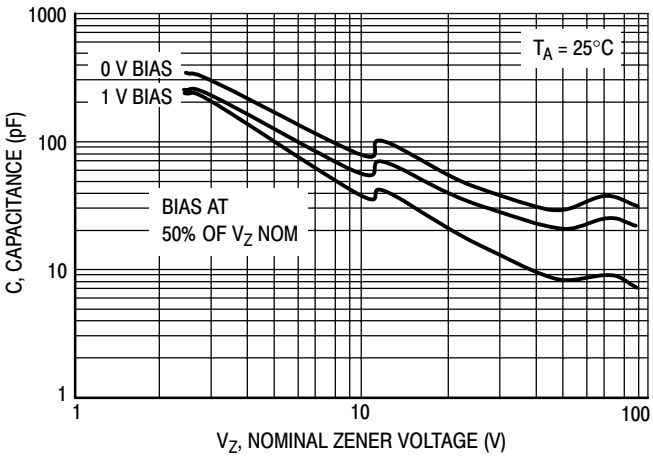


Figure 7. Typical Capacitance

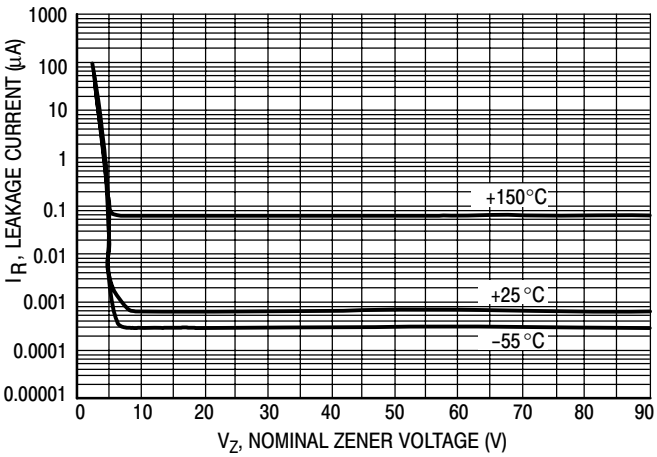


Figure 8. Typical Leakage Current

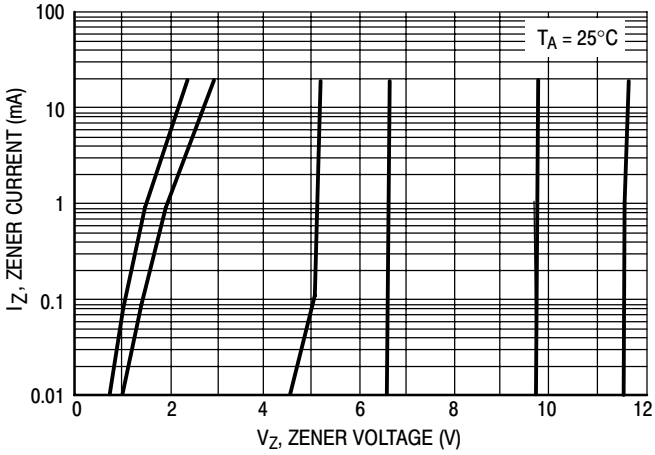


Figure 9. Zener Voltage versus Zener Current (V_Z Up to 12 V)

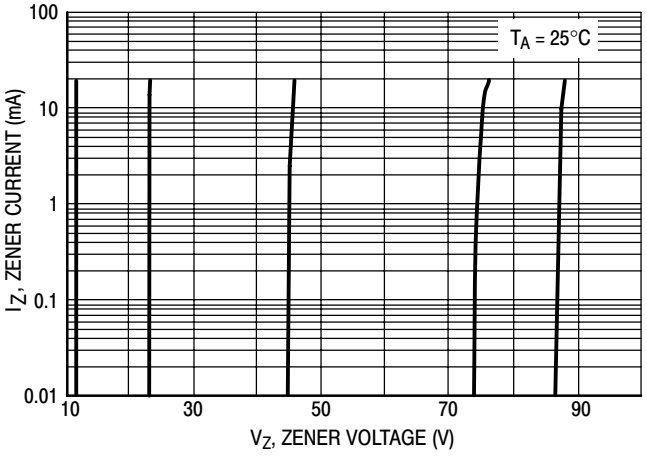
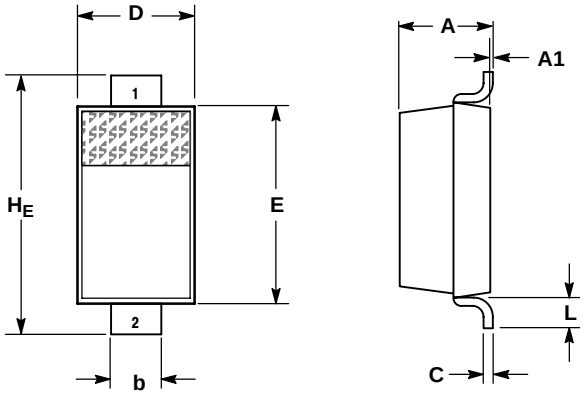


Figure 10. Zener Voltage versus Zener Current (12 V to 91 V)

PACKAGE DIMENSIONS

SOD−123
CASE 425−04
ISSUE E

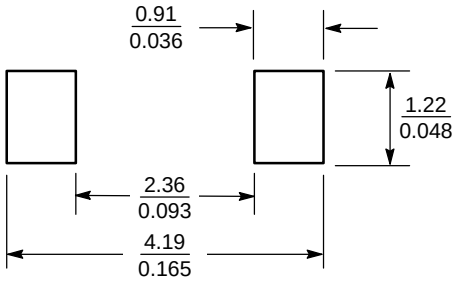


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
A	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
c	---	---	0.15	---	---	0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
E	2.54	2.69	2.84	0.100	0.106	0.112
H_E	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25	---	---	0.010	---	---

STYLE 1:
PIN 1. CATHODE
2. ANODE

SOLDERING FOOTPRINT*



SCALE 10:1 $\left(\frac{\text{mm}}{\text{inches}}\right)$

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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